

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

METHODS TO CREATE A USER PROFILE AND TO SPECIFY A SUGGESTION FOR A NEXT SELECTION OF A USER
for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Deutschland GmbH, a German corporation, with offices at Hugo-Eckener-Str. 20, 50829 Koeln, Germany (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: International Serial Number: PCT/EP2003/009473, International Filing Date: August 27, 2003.

This assignment executed on the dates indicated below.

Silke GORONZY

Name of first or sole inventor

Erlangen, Germany

Residence of first or sole inventor

Silke Goronzy

Signature of first or sole inventor

Execution date of U.S. Patent Application

07.02.05

Date of this assignment

Ralf KOMPE

Name of second inventor

Röttenbach, Germany

Residence of second inventor

Ralf Kompe

Signature of second inventor

Execution date of U.S. Patent Application

7.2.05

Date of this assignment

Christian HYING

Name of third inventor

Stuttgart, Germany

Residence of third inventor

Christian Hying

Signature of third inventor

Execution date of U.S. Patent Application

13.2.2005

Date of this assignment

ADDITIONAL INVENTORS

Zica VALSAN

Name of fourth inventor

Stuttgart, Germany

Residence of fourth inventor

Signature of fourth inventor

Execution date of U.S. Patent Application

02.02.2005
Date of this assignment

Robert MENCL

Name of fifth inventor

Dortmund, Germany

Residence of fifth inventor

Signature of fifth inventor

Execution date of U.S. Patent Application

27.09.2005
Date of this assignment

Helmut WAIS

Name of sixth inventor

Tapfheim, Germany

Residence of sixth inventor

Signature of sixth inventor

Execution date of U.S. Patent Application

29.10.2005
Date of this assignment

Thomas KEMP

Name of seventh inventor

Esslingen, Germany

Residence of seventh inventor

Signature of seventh inventor

Execution date of U.S. Patent Application

26.1.2005
Date of this assignment

Sunna TORGE

Name of eighth inventor

Freiburg, Germany

Residence of eighth inventor

Signature of eighth inventor

Execution date of U.S. Patent Application

1.10.05
Date of this assignment

Martin EMELE

Name of ninth inventor

Bad Homburg, Germany

Residence of ninth inventor

Signature of ninth inventor

Execution date of U.S. Patent Application

22.10.05
Date of this assignment